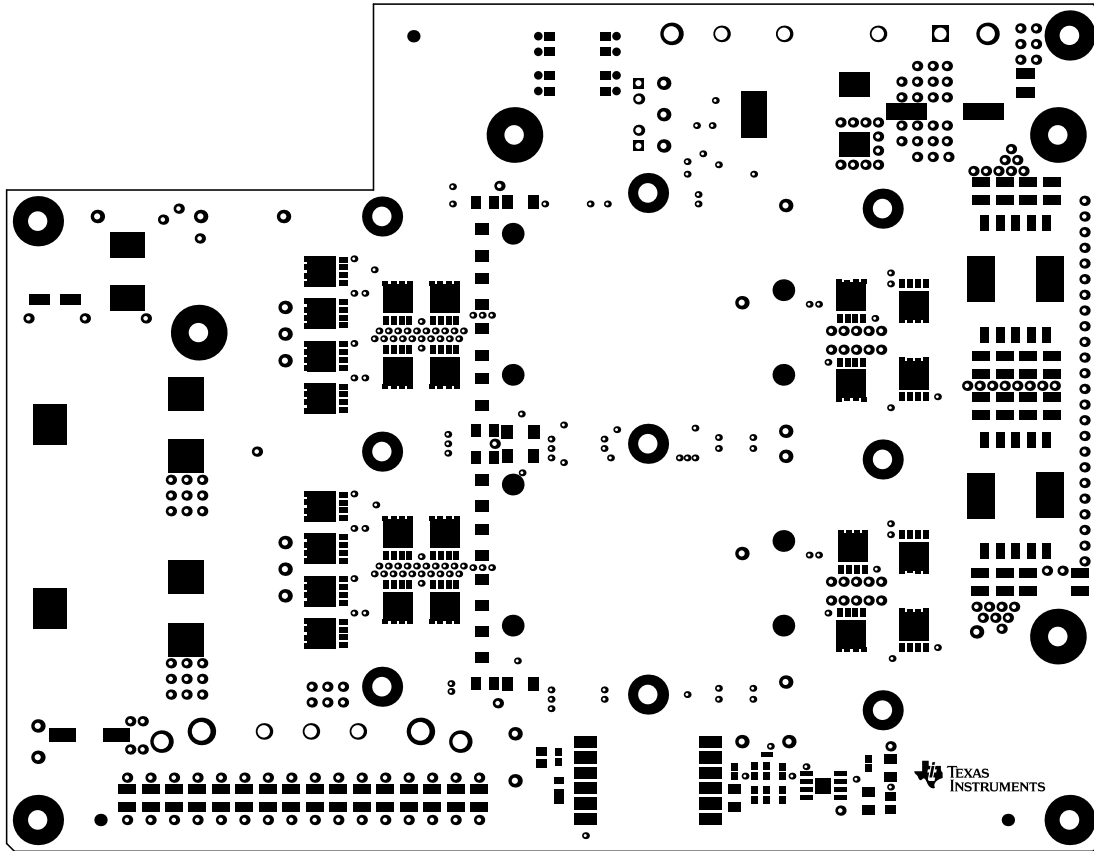
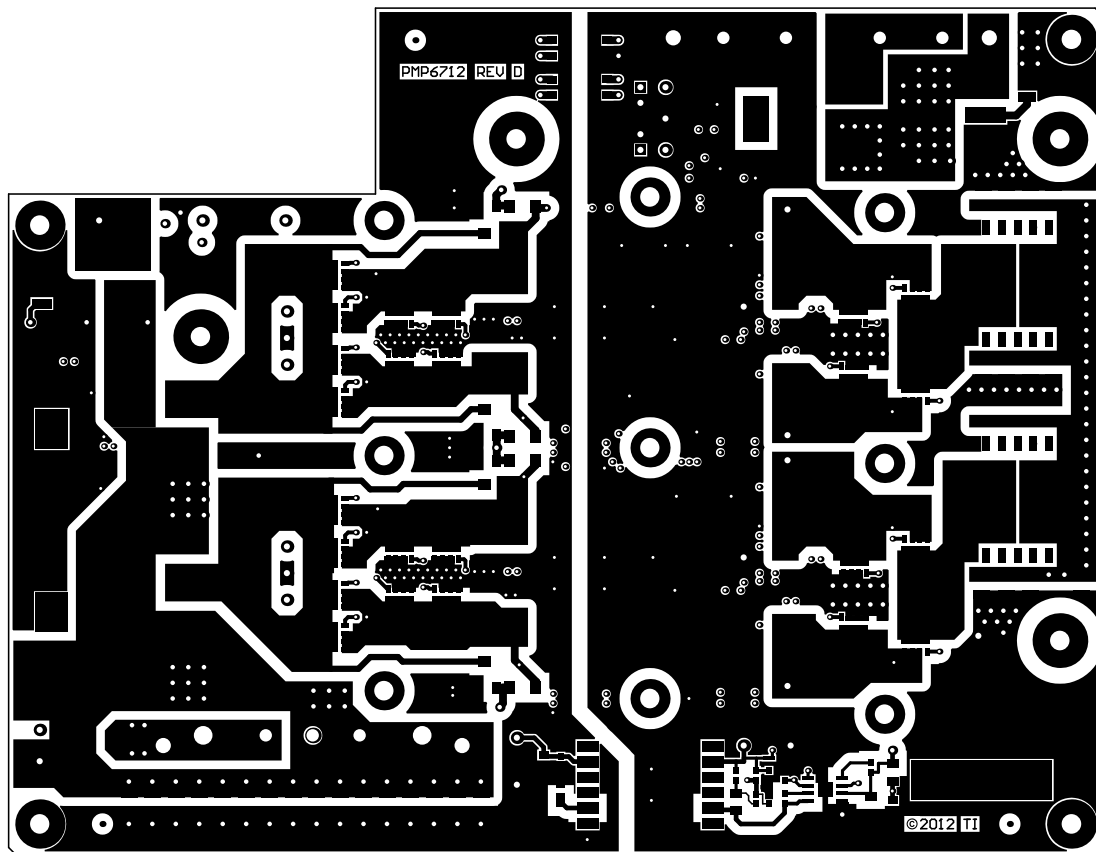


| | | |
|----------------------------------|-----------------------------------|--------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = Top Overlay | TEXAS INSTRUMENTS | |
| PLOT NAME = Top Overlay | GENERATED : 10/30/2012 4:46:49 PM | |

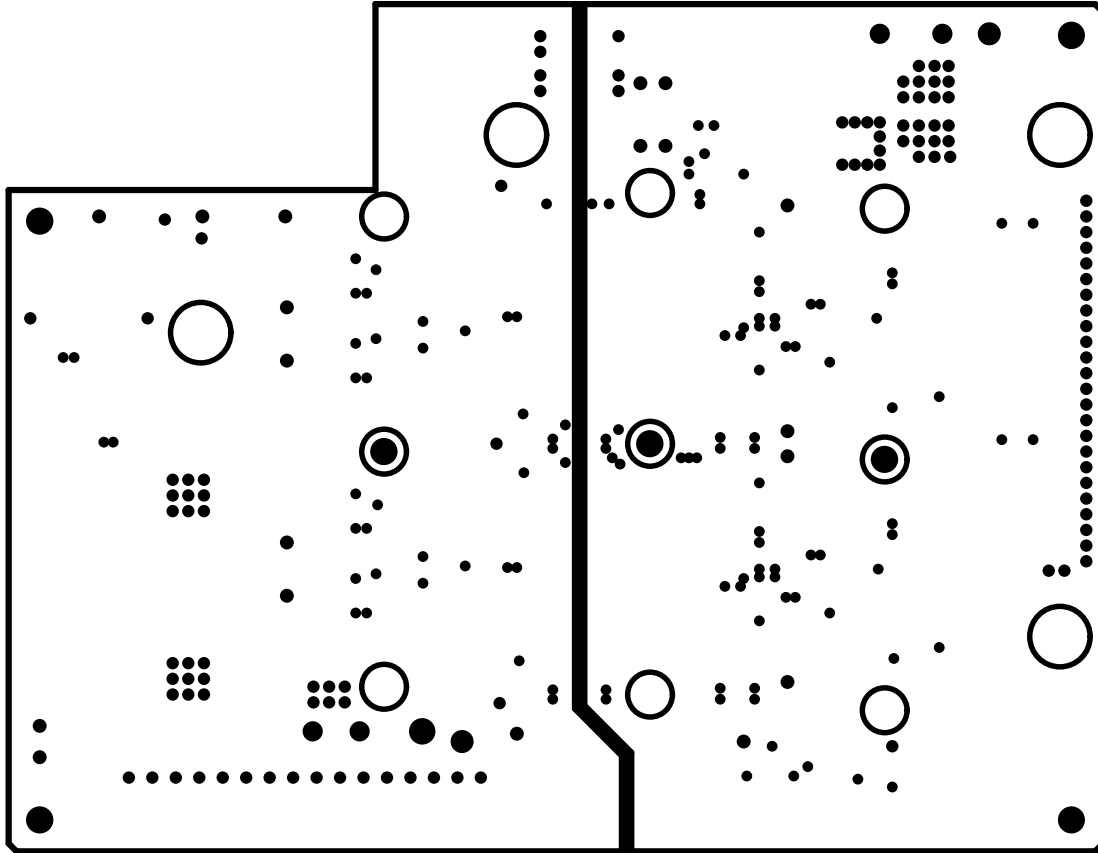


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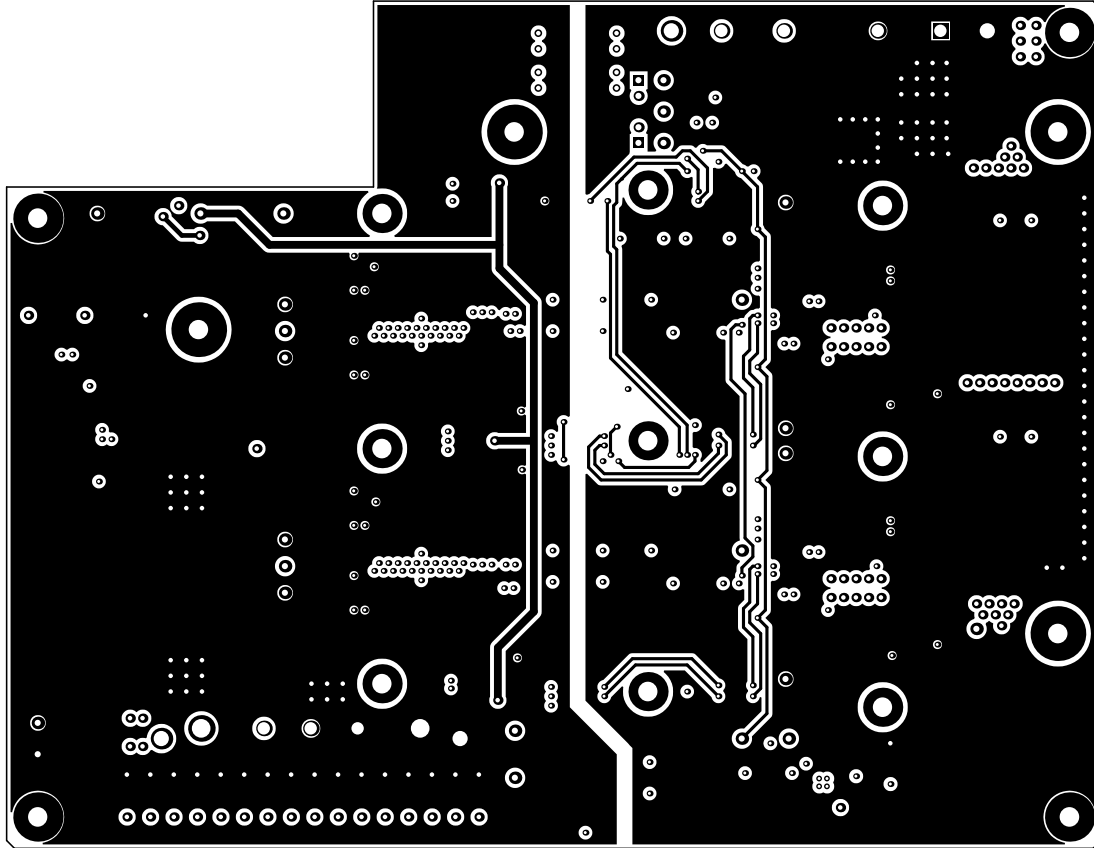
| | | |
|----------------------------------|------------------|-------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = Top Solder | | TEXAS INSTRUMENTS |
| PLOT NAME = Top Solder Mask | GENERATED | : 10/30/2012 4:46:50 PM |



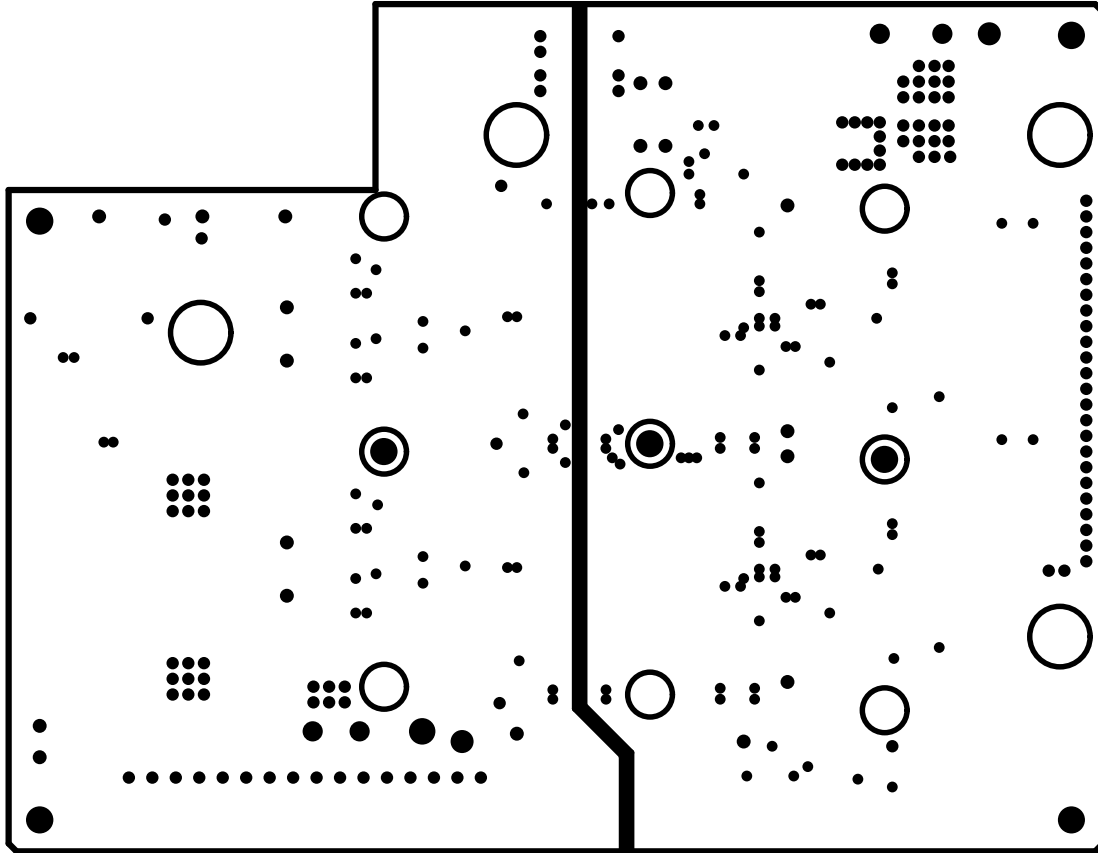
| | | |
|----------------------------------|------------------|-------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = Top | | TEXAS INSTRUMENTS |
| PLOT NAME = Top Layer | GENERATED | : 10/30/2012 4:46:50 PM |



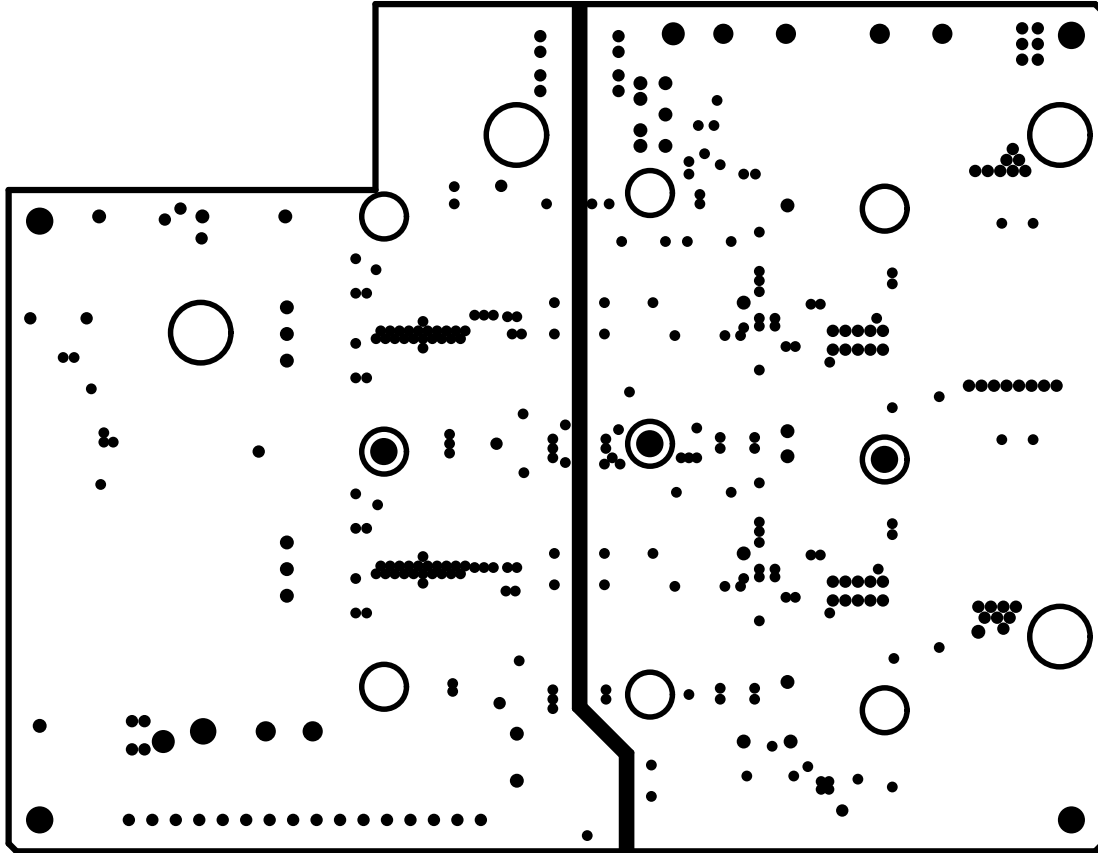
| | | |
|----------------------------------|------------------|-------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = G02 | | TEXAS INSTRUMENTS |
| PLOT NAME = G02 | GENERATED | : 10/30/2012 4:46:51 PM |



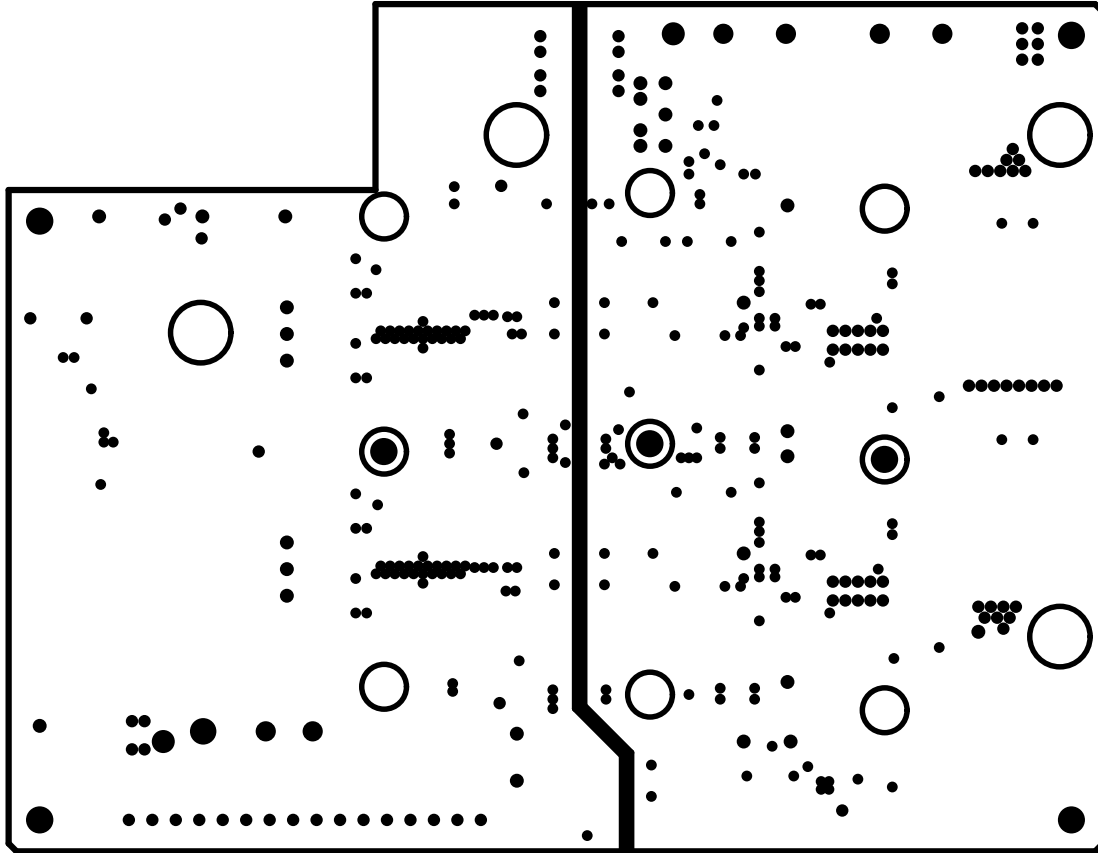
| | | | |
|----------------------------------|------------------|-----------------------------------|-------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D | |
| LAYER NAME = T03 | | | TEXAS INSTRUMENTS |
| PLOT NAME = T03 | | GENERATED : 10/30/2012 4:46:51 PM | |



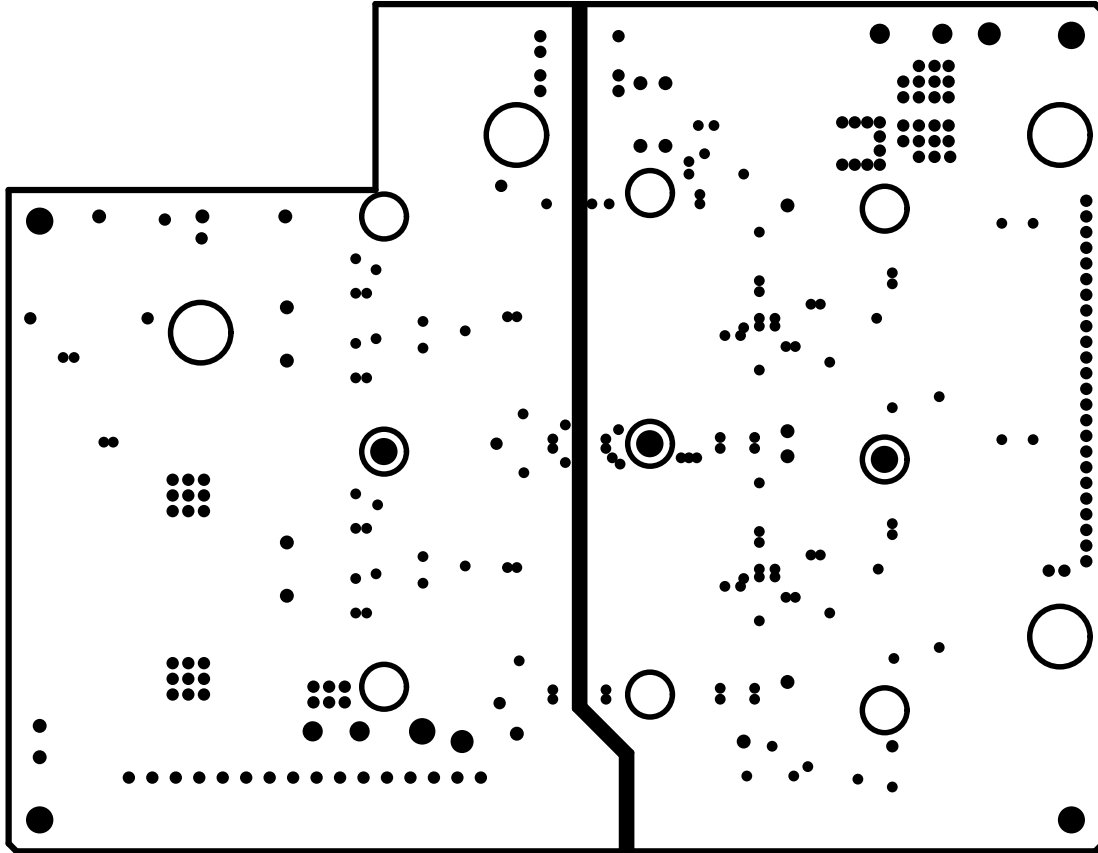
| | | |
|----------------------------------|------------------|-------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = G04 | | TEXAS INSTRUMENTS |
| PLOT NAME = G04 | GENERATED | : 10/30/2012 4:46:52 PM |



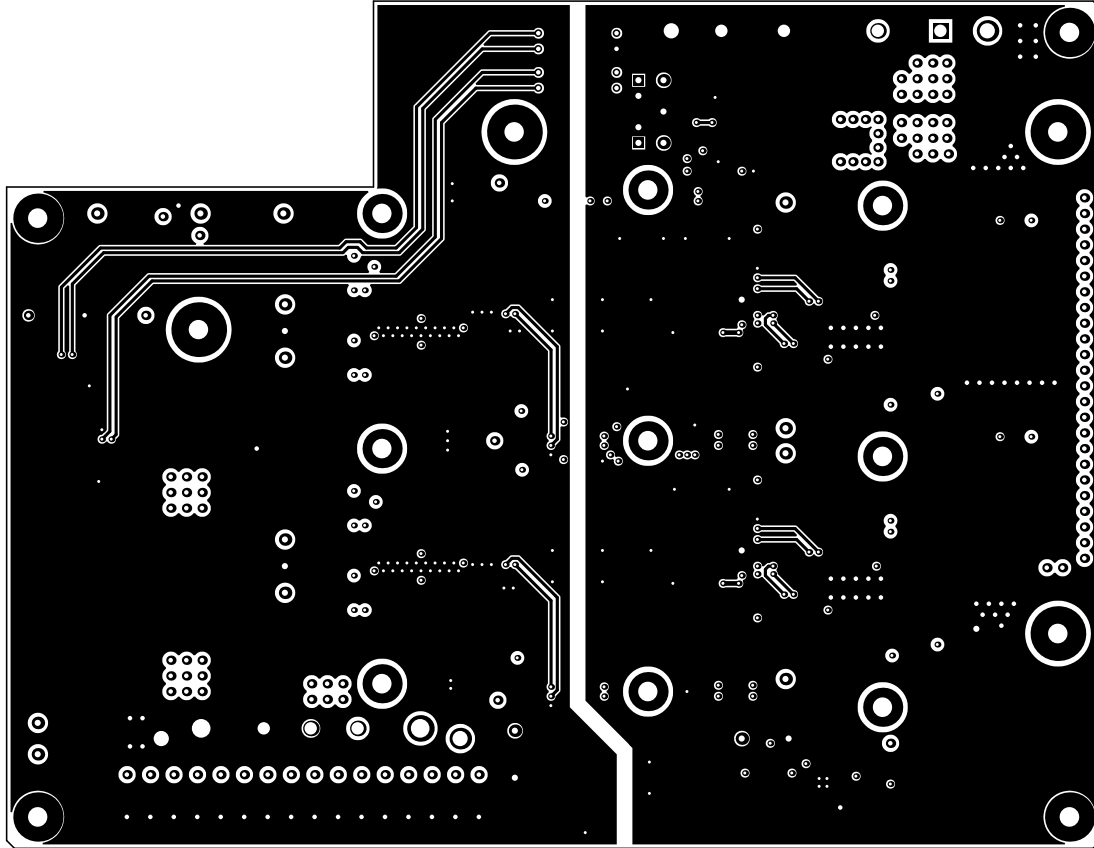
| | | |
|----------------------------------|------------------|-------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = P05 | | TEXAS INSTRUMENTS |
| PLOT NAME = P05 | GENERATED | : 10/30/2012 4:46:52 PM |



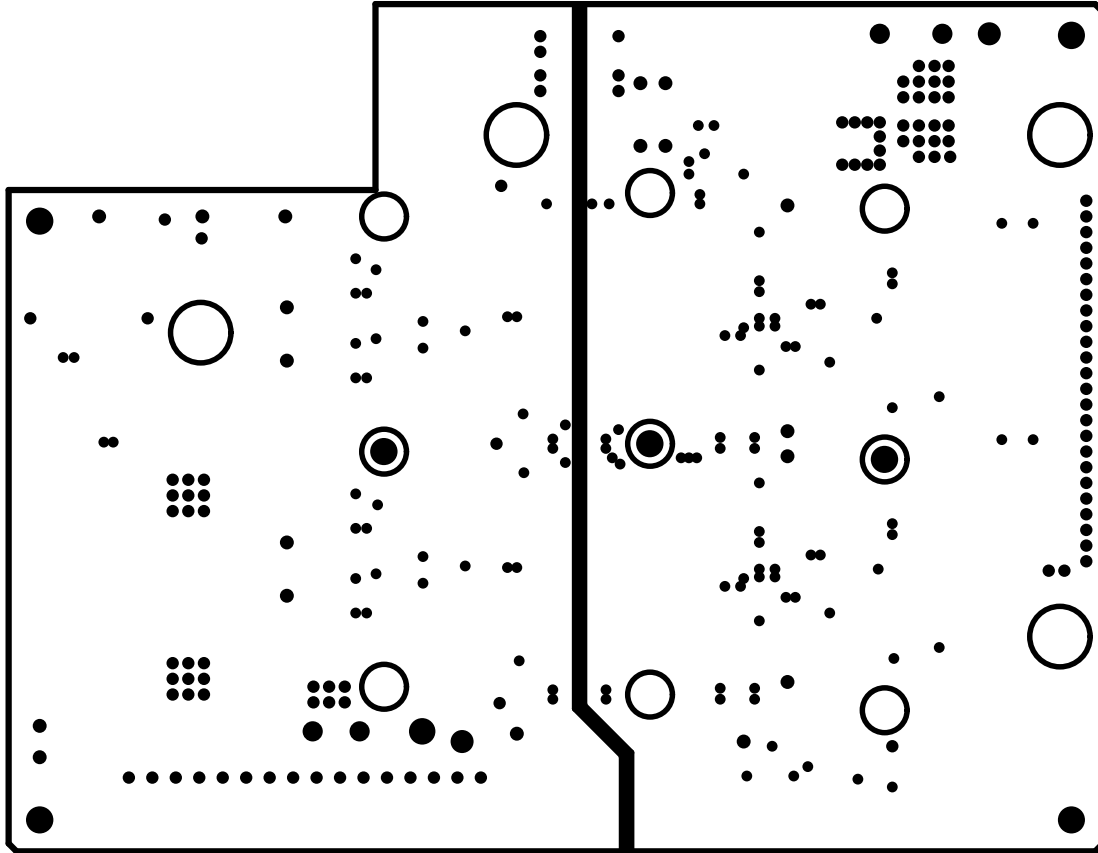
| | | |
|----------------------------------|------------------|-------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = P06 | | TEXAS INSTRUMENTS |
| PLOT NAME = P06 | GENERATED | : 10/30/2012 4:46:53 PM |



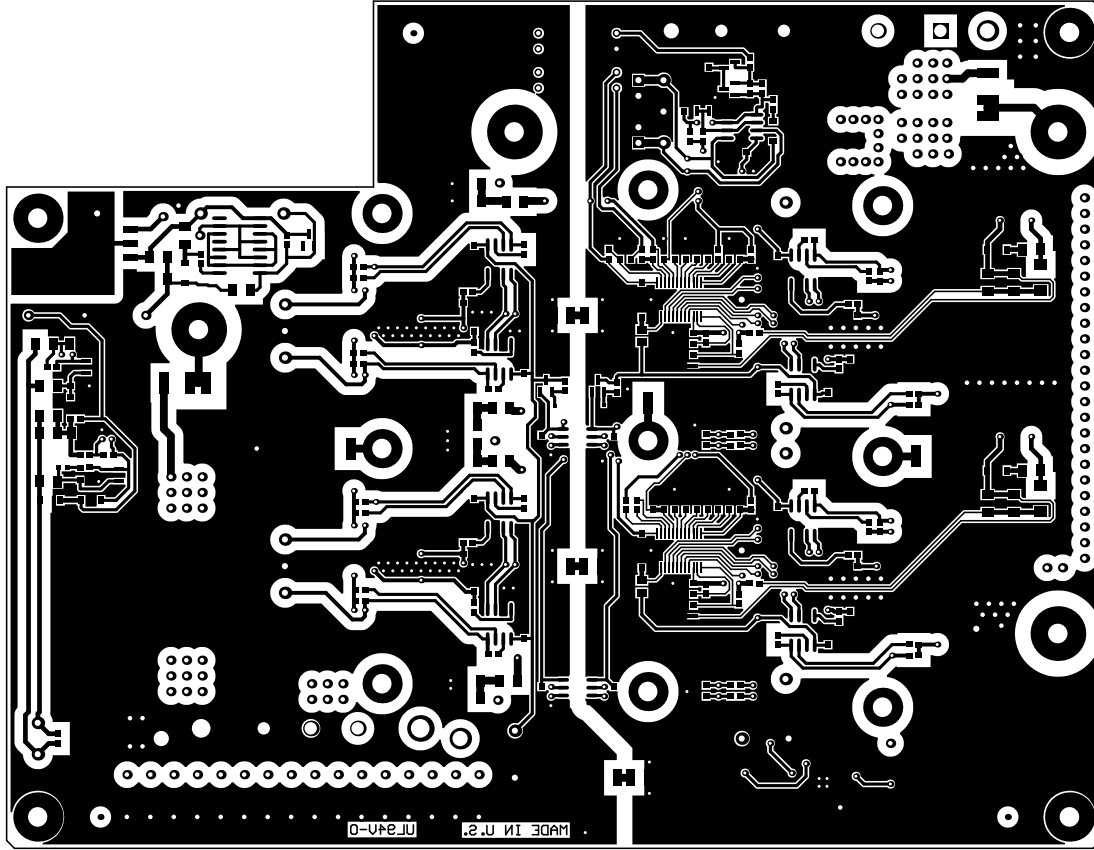
| | | |
|----------------------------------|------------------|-------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = G07 | | TEXAS INSTRUMENTS |
| PLOT NAME = G07 | GENERATED | : 10/30/2012 4:46:53 PM |



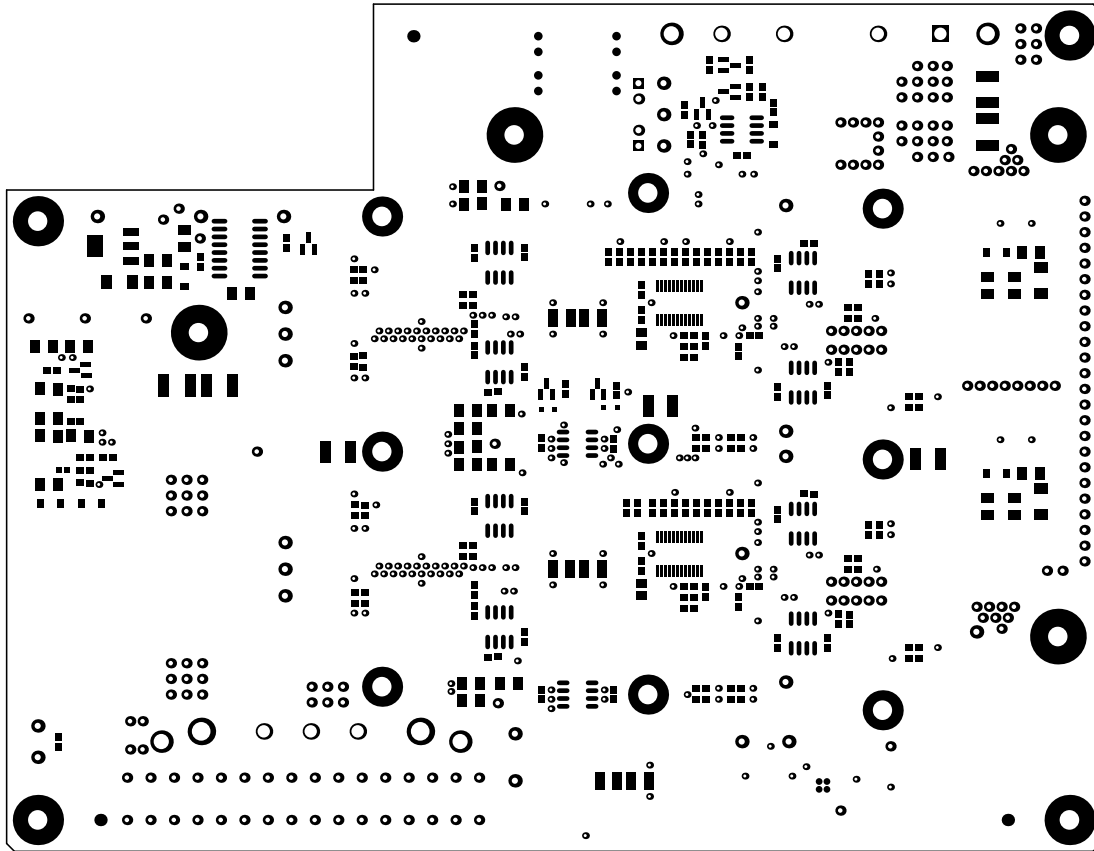
| | | |
|----------------------------------|------------------|-------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = T08 | | TEXAS INSTRUMENTS |
| PLOT NAME = T08 | GENERATED | : 10/30/2012 4:46:53 PM |



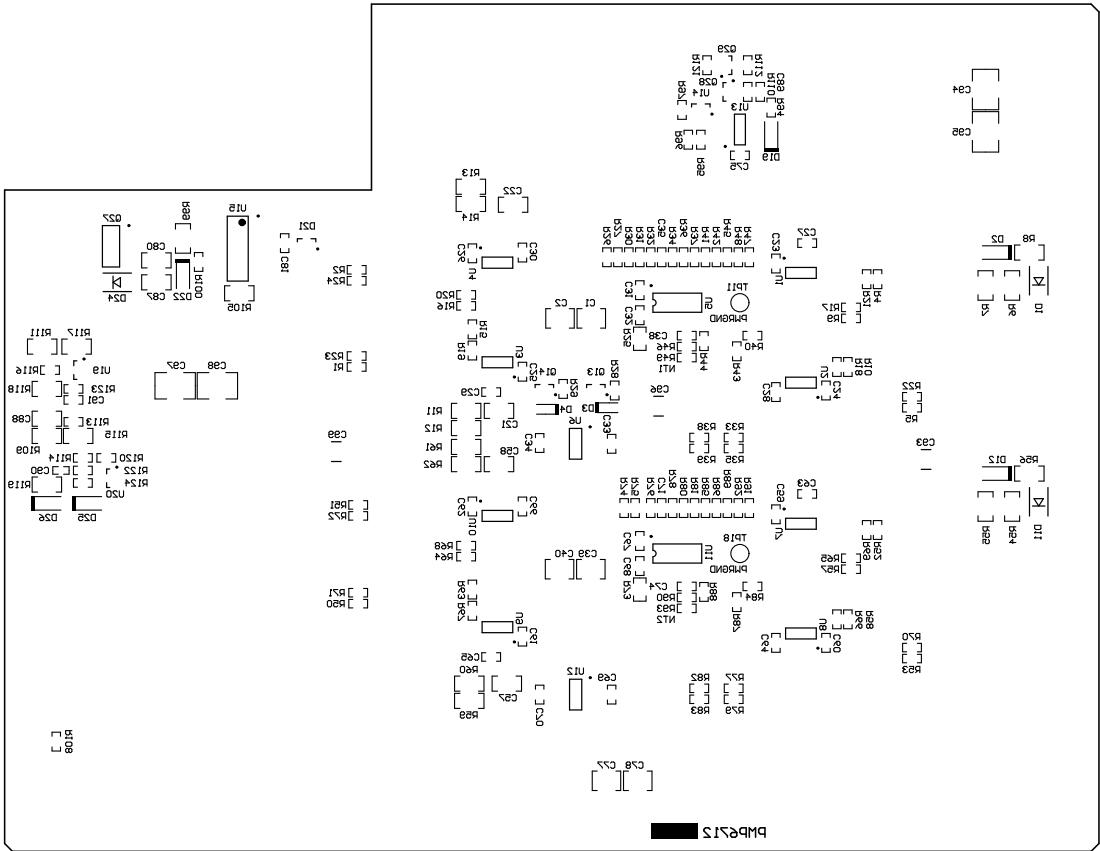
| | | |
|----------------------------------|------------------|-------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = G09 | | TEXAS INSTRUMENTS |
| PLOT NAME = G09 | GENERATED | : 10/30/2012 4:46:54 PM |



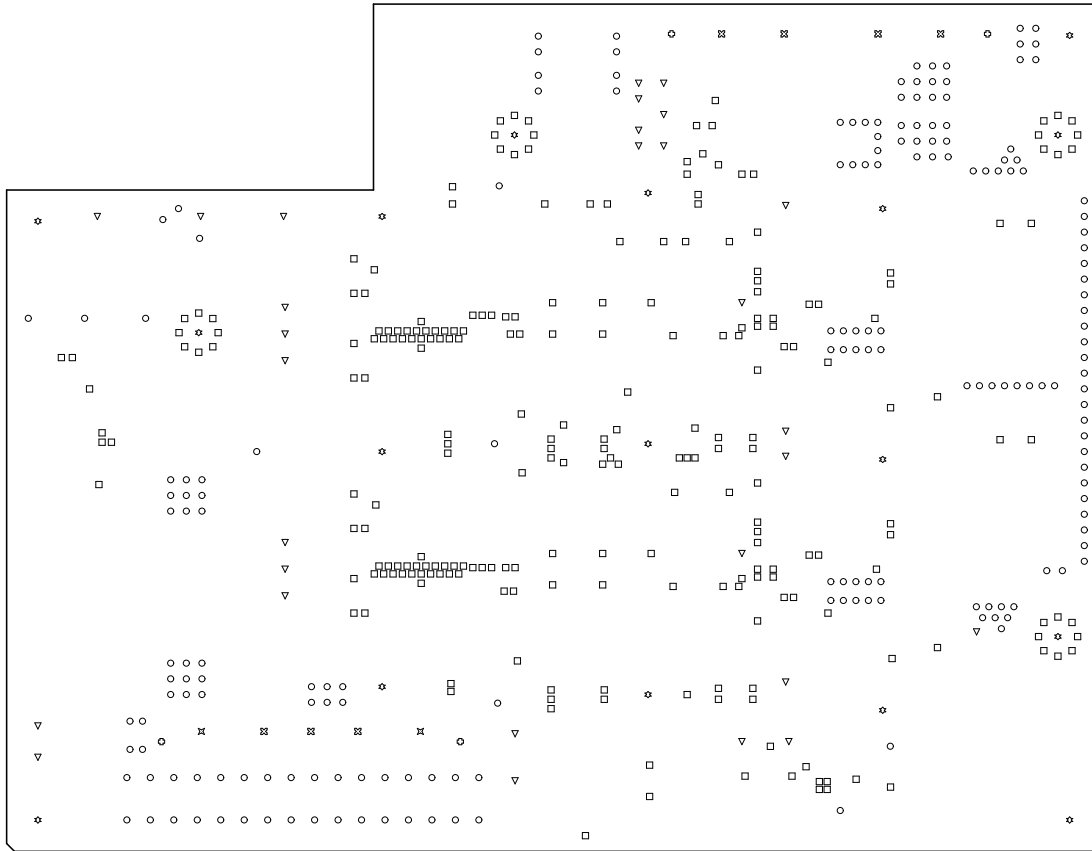
| | | |
|----------------------------------|------------------|-------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = Bottom | | TEXAS INSTRUMENTS |
| PLOT NAME = Bottom Layer | GENERATED | : 10/30/2012 4:46:54 PM |



| | | |
|----------------------------------|------------------|-------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = Bottom Solder | | TEXAS INSTRUMENTS |
| PLOT NAME = Bottom Solder Mask | GENERATED | : 10/30/2012 4:46:55 PM |



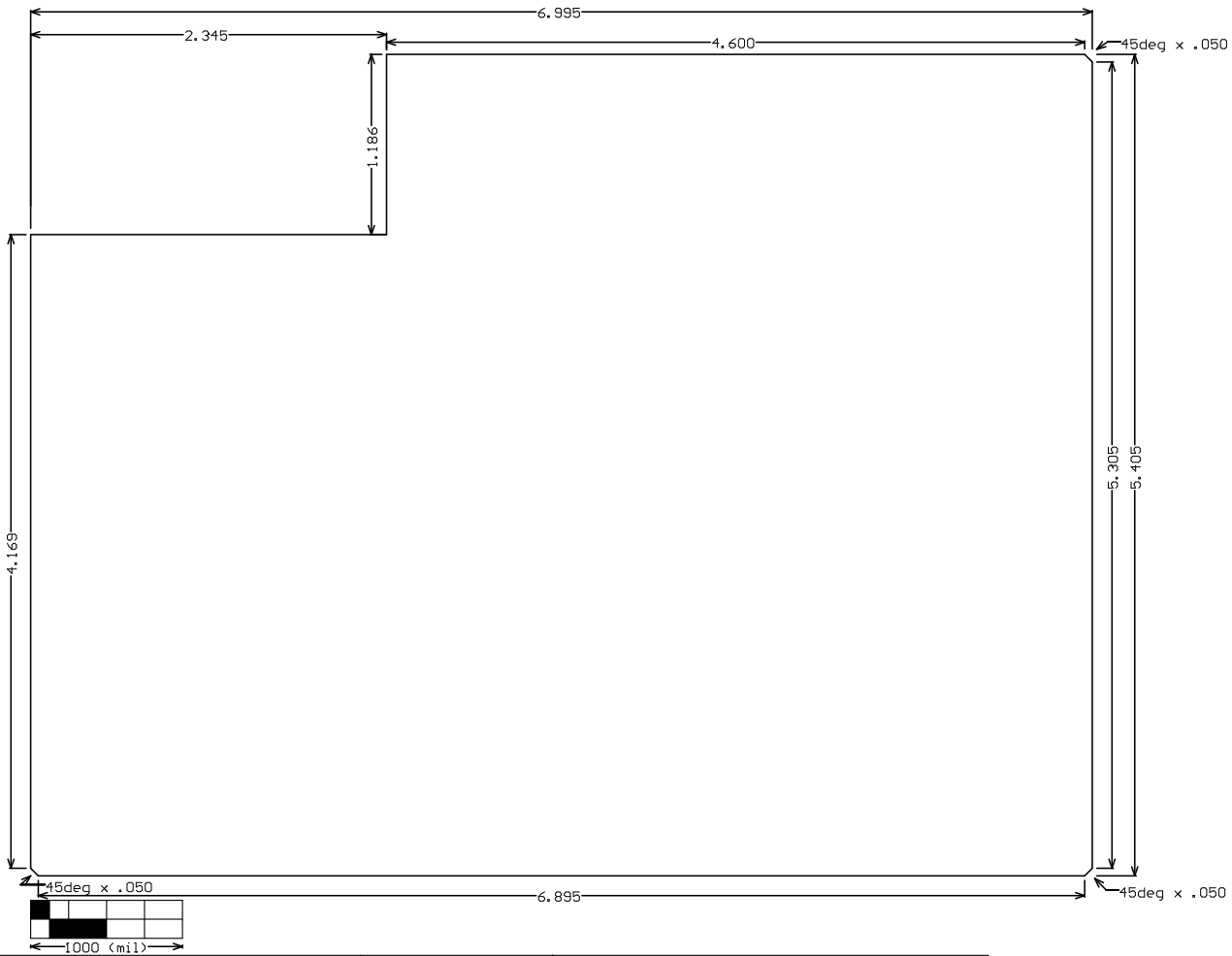
| | | |
|----------------------------------|-----------------------------------|--------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = Bottom Overlay | TEXAS INSTRUMENTS | |
| PLOT NAME = Bottom Overlay | GENERATED : 10/30/2012 4:46:55 PM | |



| Symbol | Hit Count | Tool Size | Plated | Hole Type |
|-----------|-----------|-------------------|--------|-----------|
| □ | 244 | 20mil (0.508mm) | PTH | Round |
| ○ | 188 | 30mil (0.762mm) | PTH | Round |
| ▽ | 29 | 40mil (1.016mm) | PTH | Round |
| ⊗ | 7 | 80mil (2.032mm) | PTH | Round |
| ⊕ | 4 | 98.425mil (2.5mm) | PTH | Round |
| ⊗ | 2 | 120mil (3.048mm) | PTH | Round |
| * | 17 | 125mil (3.175mm) | PTH | Round |
| 491 Total | | | | |

Drill Table

| | | |
|----------------------------------|-----------------------------------|--------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = Drill Drawing | TEXAS INSTRUMENTS | |
| PLOT NAME = Drill Drawing | GENERATED : 10/30/2012 4:46:56 PM | |



| | | |
|----------------------------------|-----------------------------------|--------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP6712 | REV: D |
| LAYER NAME = M2 Board Dimensions | TEXAS INSTRUMENTS | |
| PLOT NAME = Board Dimensions | GENERATED : 10/30/2012 4:46:56 PM | |

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